

5th Version of DevIC Series of IEEE Int. Conf. on "2023 Devices for Integrated Circuit"

DevIC 2023 (IEEE Record No. 57758)

Organized by IEEE KGEC SB Chapter and Dept. of ECE, KGEC
in Technical Partnership with IETE Kolkata Chapter and IEEE EDS Kolkata Chapter

Date: 7th – 8th April, 2023

Venue: Kalyani Govt. Engg. College, Kalyani, West Bengal, India

Conference url: <https://edu.ieee.org/in-kgec/devic-2023/>

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Accepted and presented papers will be submitted for inclusion into IEEE Xplore subject to meeting IEEE Xplore's scope and quality requirements

Few Selected Extended version of the presented papers will be sent to Microsystem Technologies, Springer and other SCI/Scopus Journals and book Chapters.

Topics of Interests but not limited to

Track 1: CMOS Processes, Devices and Integration

Track-2: VLSI Technology and Circuits

Track 3: Innovative Systems

Track-4: Emerging Non-CMOS Devices & Technologies

Track 5: Device Modelling & Simulation

Track 6: Device Characterization, Reliability & Yield

Track 7: Devices with New material systems

Track 8: Devices for Low power applications

Track 9: Low dimensional devices

Track 10: Design and Simulation of Circuits with nanoscale devices

Track 11: MEMS, Sensors & Display Technologies

Track 12: Advanced & Emerging Memories

Track 13: High frequency wireless communication

Link for paper submission:

<https://cmt3.research.microsoft.com/DevIC2023>

Important Deadline

Last date for paper submission: **15th February 2023**

Last Date for acceptance: **1st March 2023**

Camera-ready paper submission: **15th March 2023**

Registration Fees

| Category | From India (in Rs) | | From Abroad (in \$) | |
|------------------|---------------------|----------|---------------------|----------|
| Authors | IEEE | NON-IEEE | IEEE | NON-IEEE |
| Student | 4000 | 4500 | 150 | 200 |
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